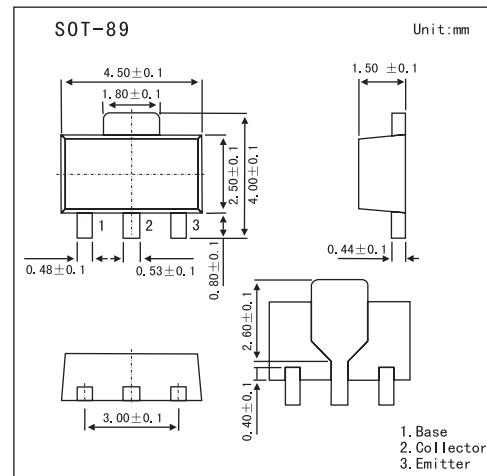


**Silicon NPN Epitaxial Planar Type****2SD2441****■ Features**

- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

**■ Absolute Maximum Ratings Ta = 25°C**

Parameter	Symbol	Rating	Unit
Collector-base voltage	V <sub>CBO</sub>	10	V
Collector-emitter voltage	V <sub>CEO</sub>	10	V
Emitter-base voltage	V <sub>EBO</sub>	7	V
Collector current	I <sub>C</sub>	2	A
Peak collector current	I <sub>CP</sub>	1.5	A
Collector power dissipation	P <sub>C</sub>	1	W
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	T <sub>stg</sub>	-55 to +150	°C

**■ Electrical Characteristics Ta = 25°C**

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Collector-base cutoff current	I <sub>CB0</sub>	V <sub>CB</sub> = 7 V, I <sub>E</sub> = 0			1	μA
Collector-base voltage	V <sub>CBO</sub>	I <sub>C</sub> = 10 μA, I <sub>E</sub> = 0	10			V
Collector-emitter voltage	V <sub>CEO</sub>	I <sub>C</sub> = 1 mA, I <sub>B</sub> = 0	10			V
Emitter-base voltage	V <sub>EBO</sub>	I <sub>E</sub> = 10 μA, I <sub>C</sub> = 0	7			V
Forward current transfer ratio	h <sub>FE</sub>	V <sub>CE</sub> = 1 V, I <sub>C</sub> = 400 mA	200		700	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 1 A, I <sub>B</sub> = 25 mA		0.17	0.25	V
Transition frequency	f <sub>T</sub>	V <sub>CB</sub> = 60 V, I <sub>E</sub> = -50 mA, f = 200 MHz		190		MHz
Collector output capacitance	C <sub>OB</sub>	V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1 MHz		50		pF
Forward voltage	V <sub>F1</sub>	I <sub>F</sub> = 500 mA			1.3	V

**■ Marking**

Marking	1V
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